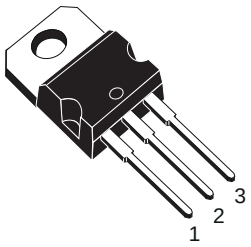
VNP14N04

"OMNIFET": FULLY AUTOPROTECTED POWER MOSFET

TYPE	V_{clamp}	$R_{DS(on)}$	I_{lim}
VNP14N04	42 V	0.07 Ω	14 A

- LINEAR CURRENT LIMITATION
- THERMAL SHUT DOWN
- SHORT CIRCUIT PROTECTION
- INTEGRATED CLAMP
- LOW CURRENT DRAWN FROM INPUT PIN
- DIAGNOSTIC FEEDBACK THROUGH INPUT PIN
- ESD PROTECTION
- DIRECT ACCESS TO THE GATE OF THE POWER MOSFET (ANALOG DRIVING)
- COMPATIBLE WITH STANDARD POWER MOSFET
- STANDARD TO-220 PACKAGE



TO-220

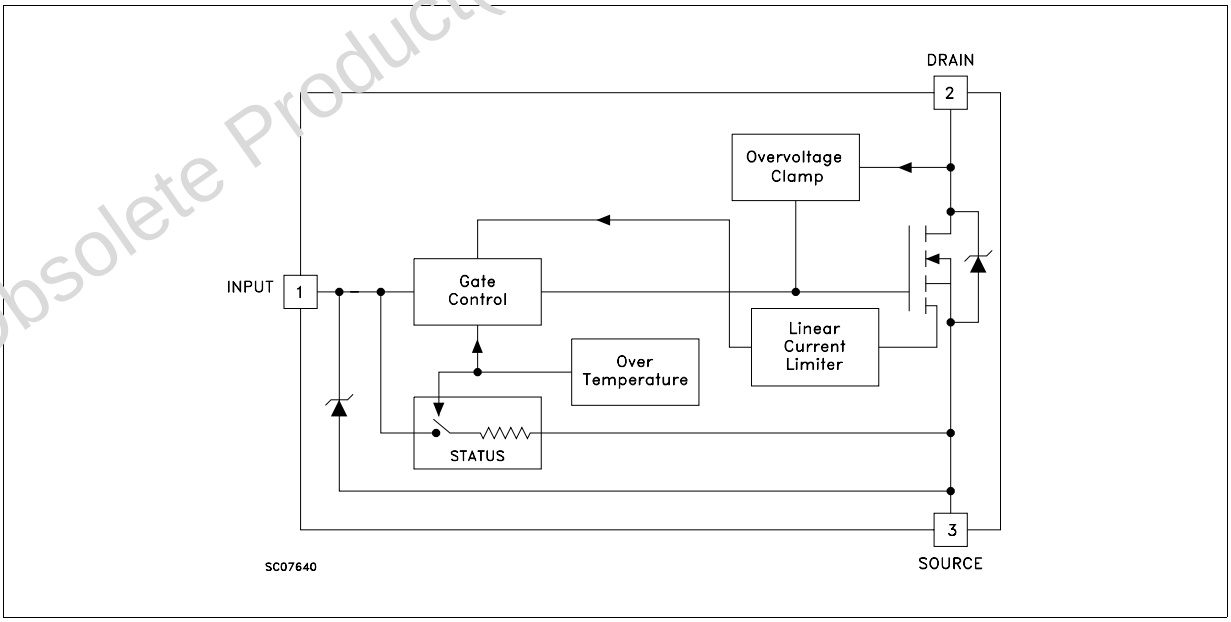
Obsolete Product(s) - Obsolete Product(s)

DESCRIPTION

The VNP14N04 is a monolithic device made using STMicroelectronics VIPower Technology, Technology, intended for replacement of standard power MOSFETS in DC to 50 KHz applications. Built-in thermal shut-down, linear current limitation and overvoltage clamp protect the chip in harsh enviroments.

Fault feedback can be detected by monitoring the voltage at the input pin.

BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATING

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source Voltage (V_{in} = 0)	Internally Clamped	V
V_{in}	Input Voltage	18	V
I_D	Drain Current	Internally Limited	A
I_R	Reverse DC Output Current	-14	A
V_{esd}	Electrostatic Discharge (C= 100 pF, R=1.5 KΩ)	2000	V
P_{tot}	Total Dissipation at T_c = 25 °C	50	W
T_j	Operating Junction Temperature	Internally Limited	°C
T_c	Case Operating Temperature	Internally Limited	°C
T_{stg}	Storage Temperature	-55 to 150	°C

THERMAL DATA

$R_{thj\text{-}case}$	Thermal Resistance Junction-case	Max	2.5	°C/W
$R_{thj\text{-}amb}$	Thermal Resistance Junction-ambient	Max	62.5	°C/W

ELECTRICAL CHARACTERISTICS (T_{case} = 25 °C unless otherwise specified)

OFF

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_{CLAMP}	Drain-source Clamp Voltage	I_D = 200 mA V_{in} = 0	36	42	48	V
V_{CLTH}	Drain-source Clamp Threshold Voltage	I_D = 2 mA V_{in} = 0	35			V
V_{INCL}	Input-Source Reverse Clamp Voltage	I_{in} = -1 mA	-1		-0.3	V
I_{DSS}	Zero Input Voltage Drain Current (V_{in} = 0)	V_{DS} = 13 V V_{in} = 0 V_{DS} = 25 V V_{in} = 0			50 200	µA µA
I_{ISS}	Supply Current from Input Pin	V_{DS} = 0 V V_{in} = 10 V		250	500	µA

ON (*)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{IN(th)}$	Input Threshold Voltage	V_{DS} = V_{in} I_D + Ii_n = 1 mA	0.8		3	V
$R_{DS(on)}$	Static Drain-source On Resistance	V_{in} = 10 V I_D = 7 A V_{in} = 5 V I_D = 7 A			0.07 0.1	Ω Ω

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
g_{fs} (*)	Forward Transconductance	V_{DS} = 13 V I_D = 7 A	8	10		S
C_{oss}	Output Capacitance	V_{DS} = 13 V f = 1 MHz V_{in} = 0		400	500	pF

Obsolete Product(s) - Obsolete Product(s)

ELECTRICAL CHARACTERISTICS (continued)

SWITCHING (**)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$ t_r $t_{d(off)}$ t_f	Turn-on Delay Time Rise Time Turn-off Delay Time Fall Time	V_{DD} = 15 V I_d = 7 A V_{gen} = 10 V R_{gen} = 10 Ω (see figure 3)		60 160 250 100	120 300 400 200	ns ns ns ns
$t_{d(on)}$ t_r $t_{d(off)}$ t_f	Turn-on Delay Time Rise Time Turn-off Delay Time Fall Time	V_{DD} = 15 V I_d = 7 A V_{gen} = 10 V R_{gen} = 1000 Ω (see figure 3)		300 1.5 5.5 1.8	500 2.2 7.5 2.5	ns µs µs µs
$(di/dt)_{on}$	Turn-on Current Slope	V_{DD} = 15 V I_D = 7 A V_{in} = 10 V R_{gen} = 10 Ω		120		A/µs
Q_i	Total Input Charge	V_{DD} = 12 V I_D = 7 A V_{in} = 10 V		30		nC

SOURCE DRAIN DIODE

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_{SD} (*)	Forward On Voltage	I_{SD} = 7 A V_{in} = 0			1.6	V
t_{rr} (**) Q_{rr} (**) I_{RRM} (**)	Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current	I_{SD} = 7 A di/dt = 100 A/µs V_{DD} = 30 V T_j = 25 °C (see test circuit, figure 5)		110 0.34 6.1		ns µC A

PROTECTION

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I_{lim}	Drain Current Limit	V_{in} = 10 V V_{DS} = 13 V V_{in} = 5 V V_{DS} = 13 V	10 10	14 14	20 20	A A
t_{dlim} (**)	Step Response Current Limit	V_{in} = 10 V V_{in} = 5 V		30 80	60 150	µs µs
T_{jsh} (**)	Overtemperature Shutdown		150			°C
T_{jrs} (**)	Overtemperature Reset		135			°C
I_{gf} (**)	Fault Sink Current	V_{in} = 10 V V_{DS} = 13 V V_{in} = 5 V V_{DS} = 13 V		50 20		mA mA
E_{as} (**)	Single Pulse Avalanche Energy	starting T_j = 25 °C V_{DD} = 20 V V_{in} = 10 V R_{gen} = 1 KΩ L = 10 mH	0.65			J

(*) Pulsed: Pulse duration = 300 µs, duty cycle 1.5 %

(**) Parameters guaranteed by design/characterization

Obsolete Product(s) - Obsolete Product(s)

PROTECTION FEATURES

During normal operation, the Input pin is electrically connected to the gate of the internal power MOSFET. The device then behaves like a standard power MOSFET and can be used as a switch from DC to 50 KHz. The only difference from the user's standpoint is that a small DC current (I_{iss}) flows into the Input pin in order to supply the internal circuitry.

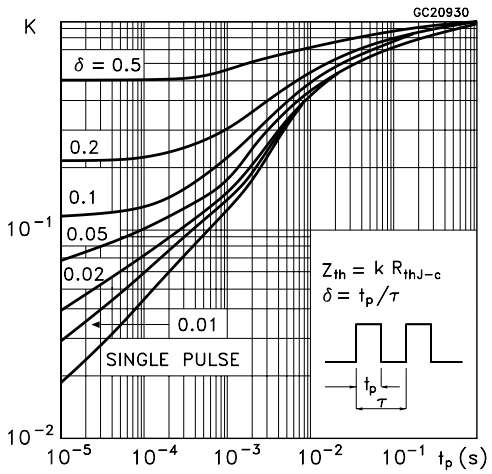
The device integrates:

- OVERVOLTAGE CLAMP PROTECTION: internally set at 42V, along with the rugged avalanche characteristics of the Power MOSFET stage give this device unrivalled ruggedness and energy handling capability. This feature is mainly important when driving inductive loads.
- LINEAR CURRENT LIMITER CIRCUIT: limits the drain current Id to Ilim whatever the Input pin voltage. When the current limiter is active, the device operates in the linear region, so power dissipation may exceed the capability of the heatsink. Both case and junction temperatures increase, and if this phase lasts long enough, junction temperature may reach the overtemperature threshold T_{jsh}.
- OVERTEMPERATURE AND SHORT CIRCUIT PROTECTION: these are based on sensing the chip temperature and are not dependent on the input voltage. The location of the sensing element on the chip in the power stage area ensures fast, accurate detection of the junction temperature. Overtemperature cutout occurs at minimum 150^{o}C. The device is automatically restarted when the chip temperature falls below 135^{o}C.
- STATUS FEEDBACK: In the case of an overtemperature fault condition, a Status Feedback is provided through the Input pin. The internal protection circuit disconnects the input from the gate and connects it instead to ground via an equivalent resistance of 100 Ω. The failure can be detected by monitoring the voltage at the Input pin, which will be close to ground potential.

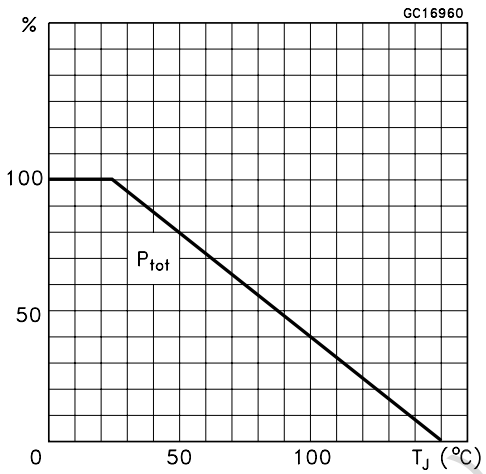
Additional features of this device are ESD protection according to the Human Body model and the ability to be driven from a TTL Logic circuit (with a small increase in $R_{DS(on)}$).

Obsolete Product(s) - Obsolete Product(s)

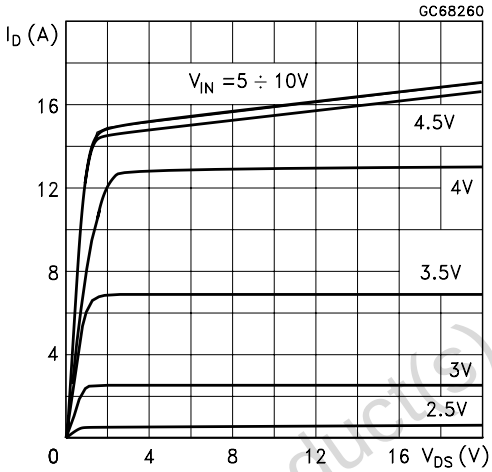
Thermal Impedance



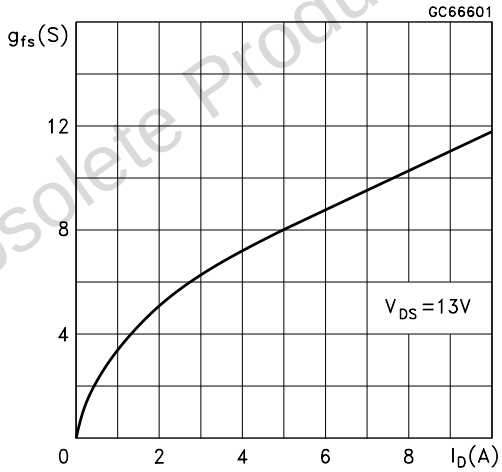
Derating Curve



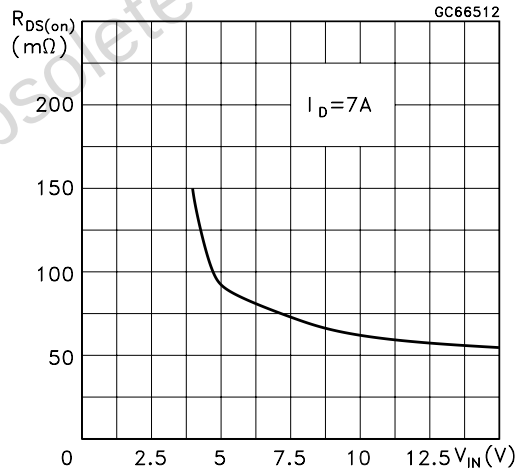
Output Characteristics



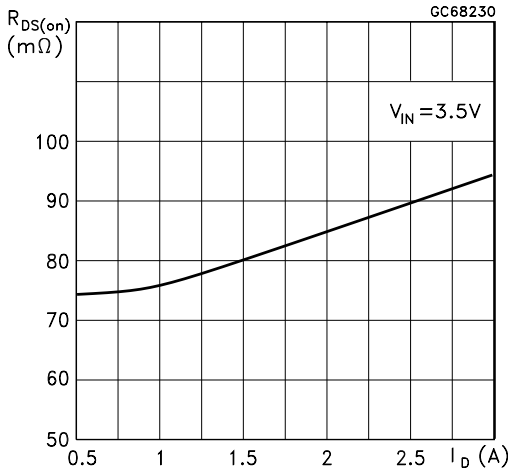
Transconductance



Static Drain-Source On Resistance vs Input Voltage

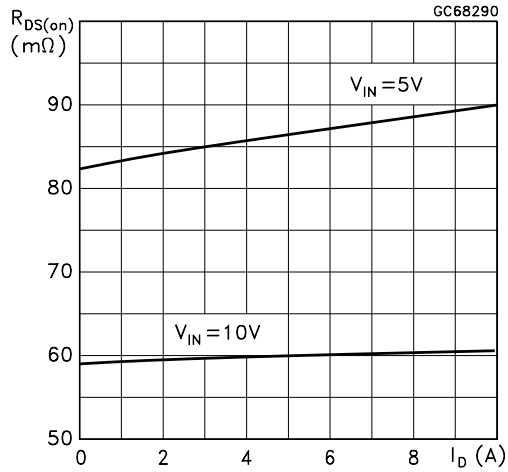


Static Drain-Source On Resistance

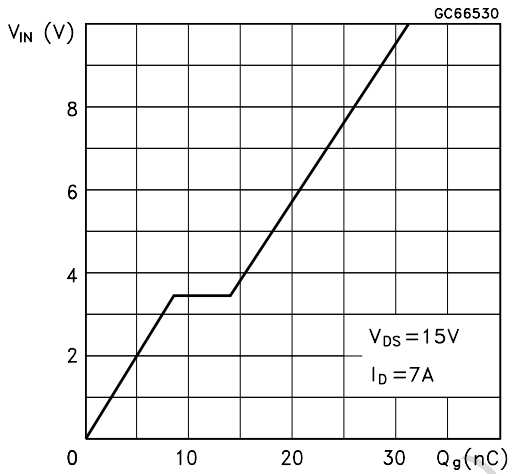


Obsolete Product(s) - Obsolete Product(s)

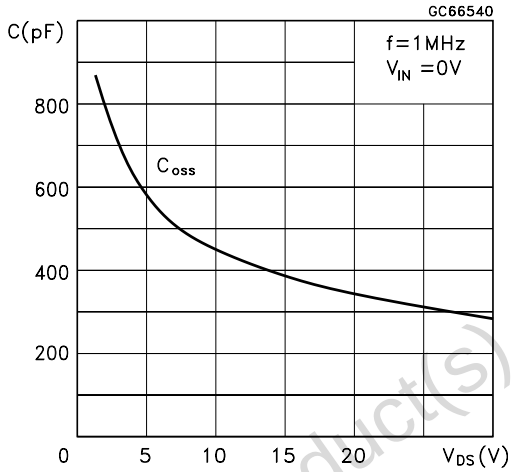
Static Drain-Source On Resistance



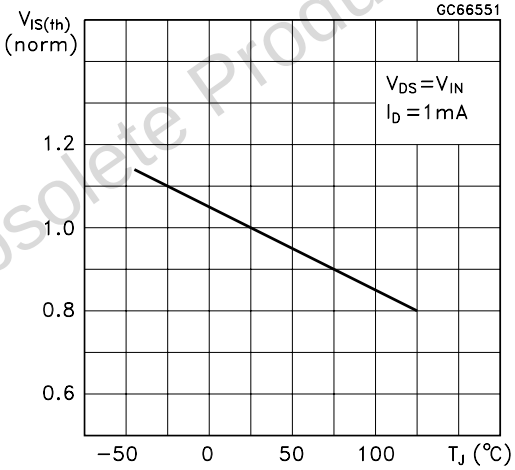
Input Charge vs Input Voltage



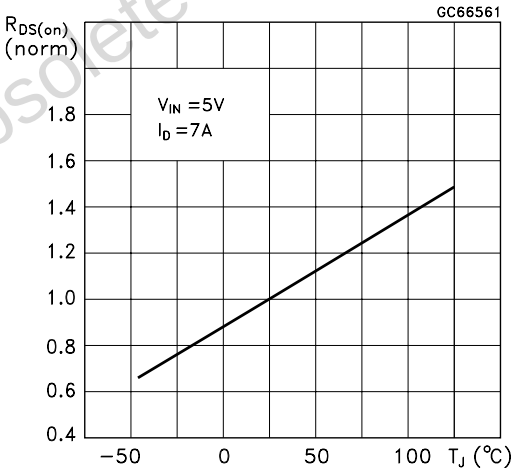
Capacitance Variations



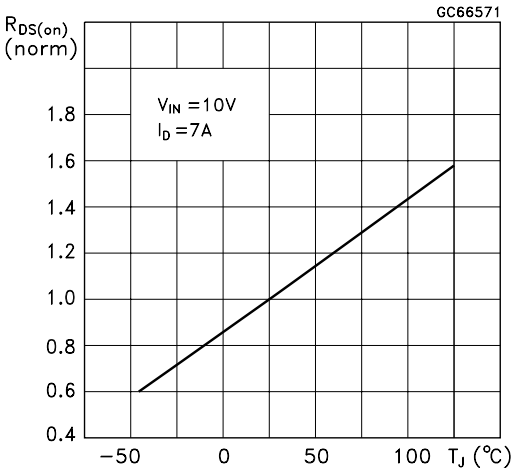
Normalized Input Threshold Voltage vs Temperature



Normalized On Resistance vs Temperature

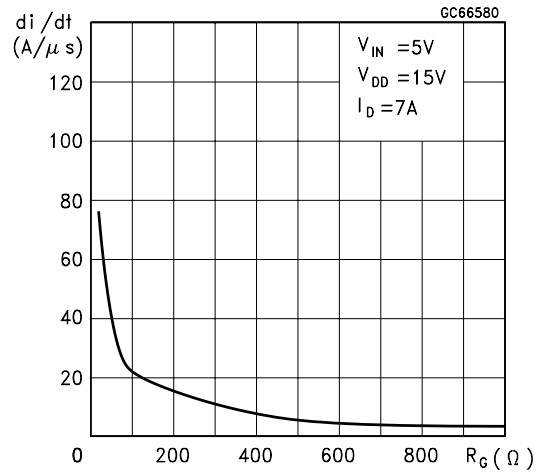


Normalized On Resistance vs Temperature

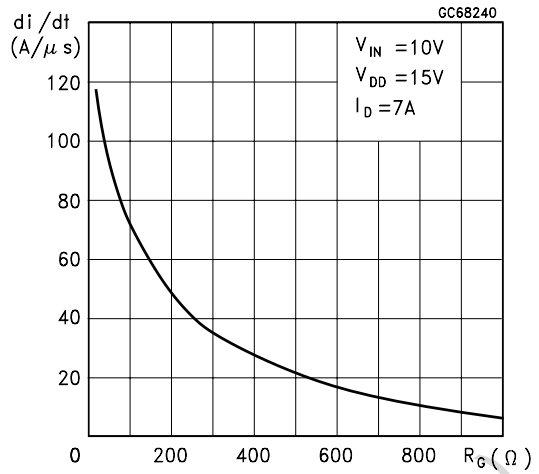


Obsolete Product(s) - Obsolete Product(s)

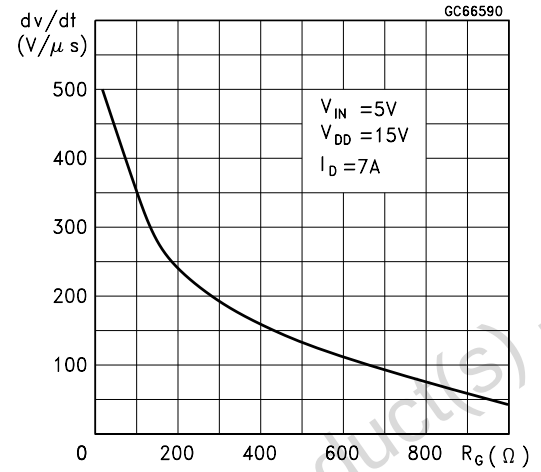
Turn-on Current Slope



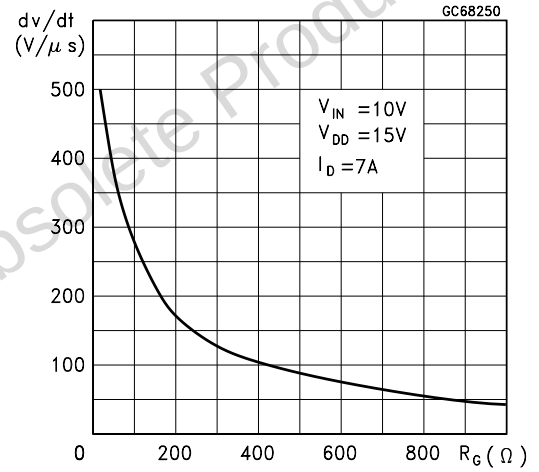
Turn-on Current Slope



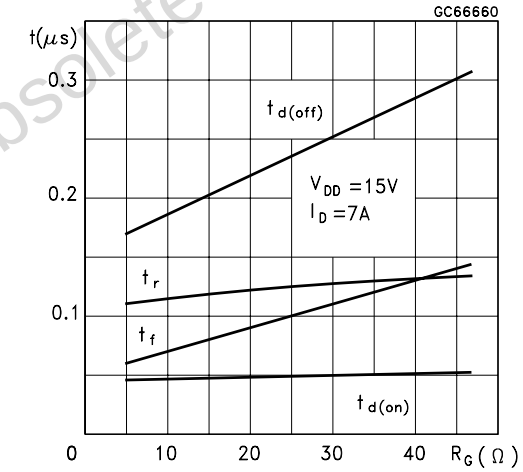
Turn-off Drain-Source Voltage Slope



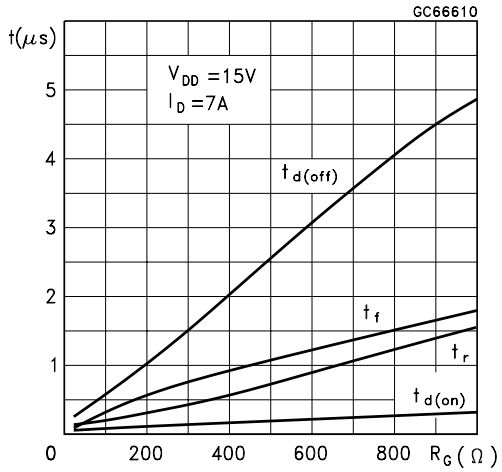
Turn-off Drain-Source Voltage Slope



Switching Time Resistive Load

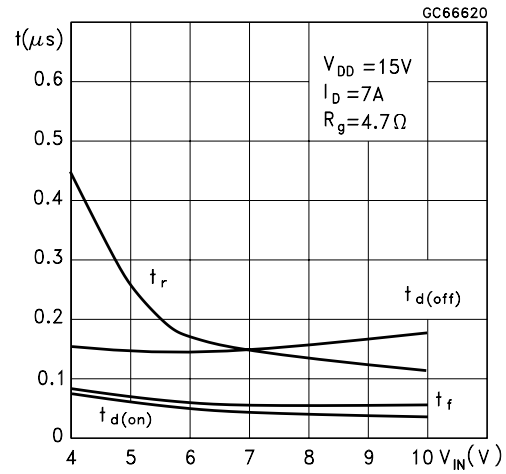


Switching Time Resistive Load

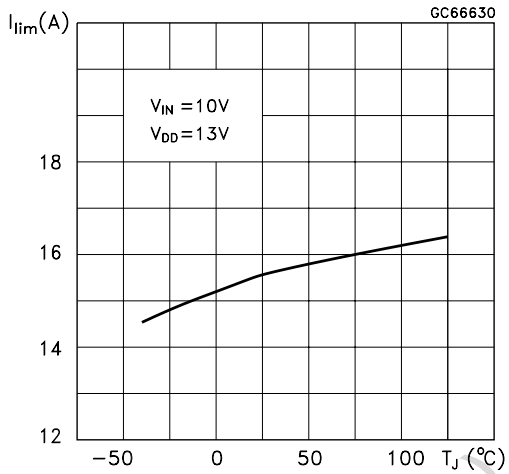


Obsolete Product(s) - Obsolete Product(s)

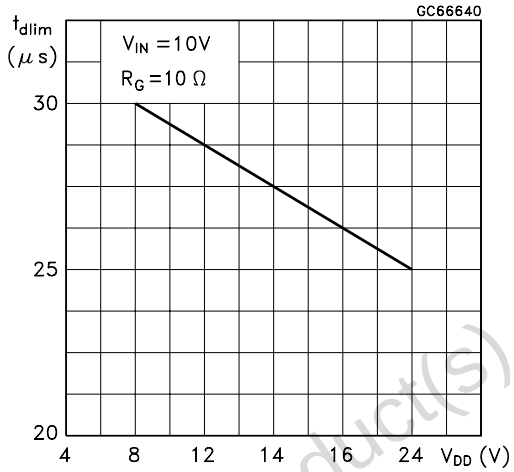
Switching Time Resistive Load



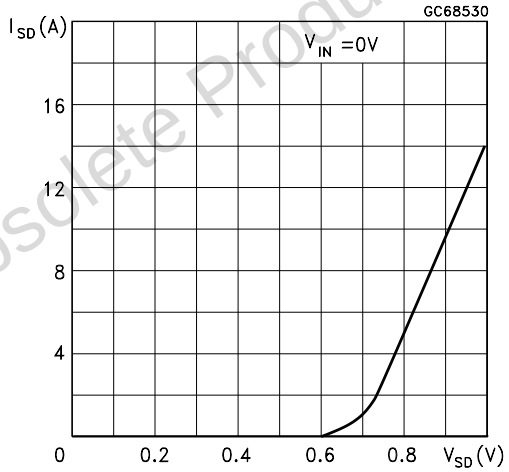
Current Limit vs Junction Temperature



Step Response Current Limit



Source Drain Diode Forward Characteristics



Obsolete Product(s) - Obsolete Product(s)

Fig. 1: Unclamped Inductive Load Test Circuits

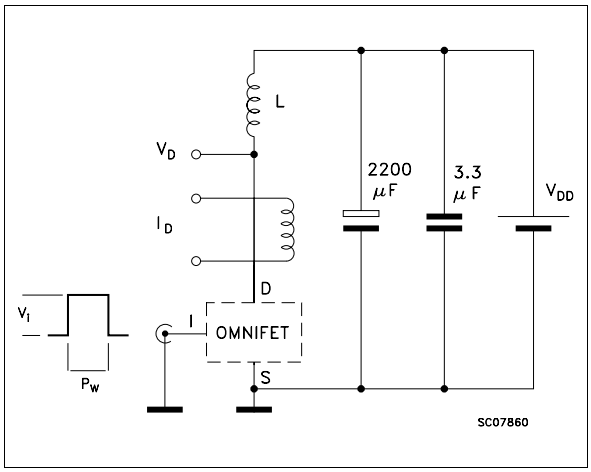


Fig. 2: Unclamped Inductive Waveforms

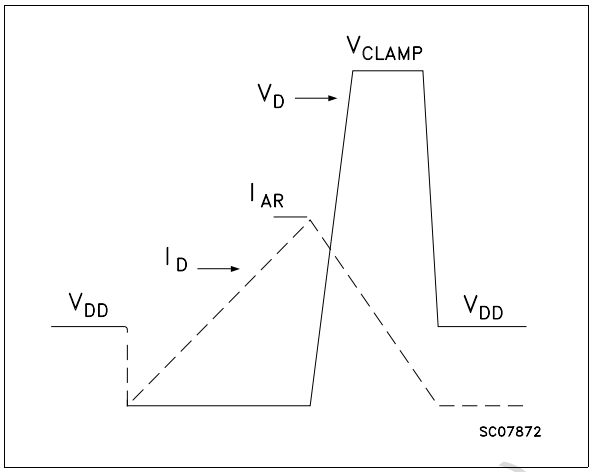


Fig. 3: Switching Times Test Circuits For Resistive Load

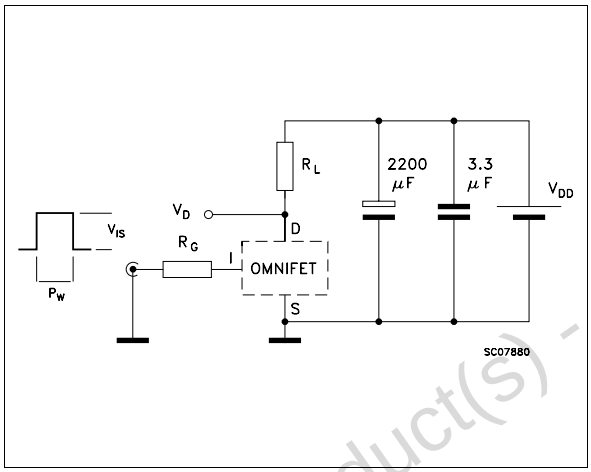


Fig. 4: Input Charge Test Circuit

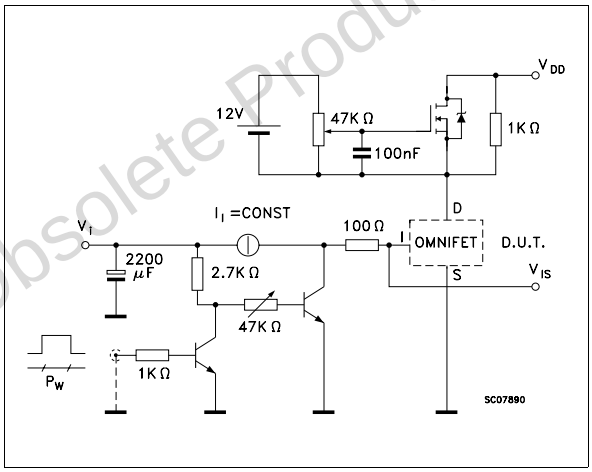


Fig. 5: Test Circuit For Inductive Load Switching And Diode Recovery Times

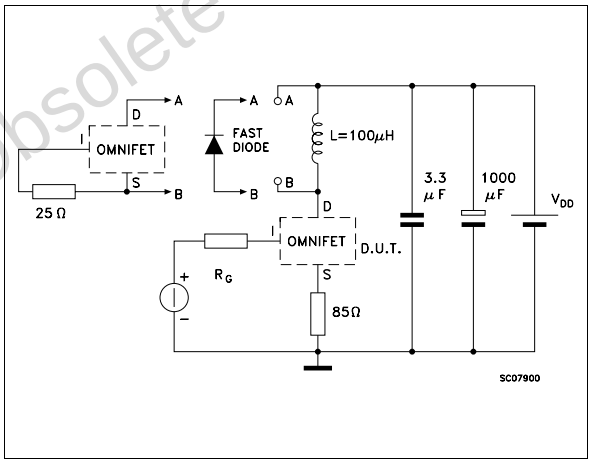
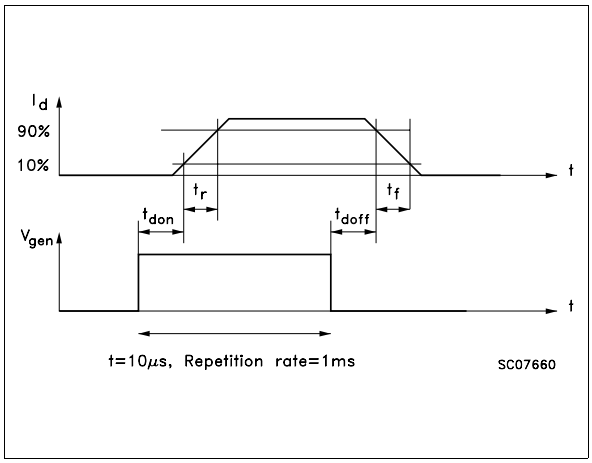


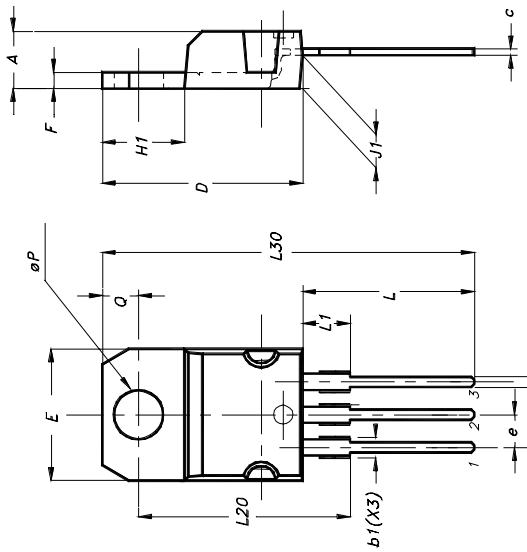
Fig. 6: Waveforms



Obsolete Product(s) - Obsolete Product(s)

TO-220 MECHANICAL DATA

DIM.	mm.		
	MIN.	TYP	MAX.
A	4.40		4.60
b	0.61		0.88
b1	1.15		1.70
c	0.49		0.70
D	15.25		15.75
E	10		10.40
e	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
∅P	3.75		3.85
Q	2.65		2.95
Package Weight	1.9Gr. (Typ.)		



Information furnished is believed to be accurate and reliable. However, STMicroelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may results from its use. No license is granted by implication or otherwise under any patent or patent rights of STMicroelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. STMicroelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of STMicroelectronics.
The ST logo is a trademark of STMicroelectronics

© 2004 STMicroelectronics - Printed in ITALY- All Rights Reserved.

STMicroelectronics GROUP OF COMPANIES
Australia - Brazil - Canada - China - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - U.S.A.

http://www.st.com